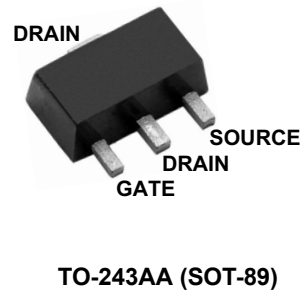
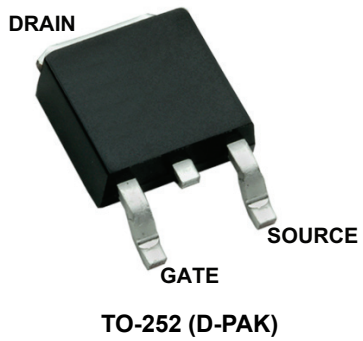


DN2450

Package Type



See [Table 2-1](#) for pin information

1.0 ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS†

Drain-to-source voltage.....	BV _{DSX}
Drain-to-gate voltage.....	BV _{DGX}
Gate-to-source voltage.....	±20V
Operating and storage temperature.....	-55°C to +150°C
Maximum junction temperature.....	150°C

† **Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

1.1 ELECTRICAL SPECIFICATIONS

TABLE 1-1: DC AND AC CHARACTERISTICS

Electrical Specifications: Unless otherwise specified, for all specifications $T_A = T_J = +25^{\circ}\text{C}$						
Symbol	Parameter	Min	Typ	Max	Units	Conditions
DC Parameters (Note 1, unless otherwise stated)						
BV_{DSX}	Drain-to-source breakdown voltage	500	–	–	V	$V_{GS} = -5.0\text{V}$, $I_D = 100\mu\text{A}$
$V_{GS(OFF)}$	Gate-to-source off voltage	-1.5	–	-3.5	V	$V_{DS} = 25\text{V}$, $I_D = 10\mu\text{A}$
$\Delta V_{GS(OFF)}$	Change in $V_{GS(OFF)}$ with temperature	–	–	-4.5	mV/ $^{\circ}\text{C}$	$V_{DS} = 25\text{V}$, $I_D = 10\mu\text{A}$ (Note 2)
I_{GSS}	Gate body leakage	–	–	100	nA	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$
$I_{D(OFF)}$	Drain-to-source leakage current	–	–	1.0	μA	$V_{DS} = BV_{DSX}$, $V_{GS} = -10\text{V}$
		–	–	1.0	mA	$V_{DS} = 0.8 BV_{DSX}$, $V_{GS} = -10\text{V}$, $T_A = 125^{\circ}\text{C}$ (Note 2)
I_{DSS}	Saturated drain-to-source current	700	–	–	mA	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$
$R_{DS(ON)}$	Static drain-to-source on-state resistance	–	7.0	10	Ω	$V_{GS} = 0\text{V}$, $I_D = 300\text{mA}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature	–	–	1.1	%/ $^{\circ}\text{C}$	$V_{GS} = 0\text{V}$, $I_D = 300\text{mA}$ (Note 2)
AC Parameters (Note 2)						
G_{FS}	Forward transconductance	500	–	–	mmho	$V_{DS} = 10\text{V}$, $I_D = 300\text{mA}$
C_{ISS}	Input capacitance	–	150	200	pF	$V_{GS} = -10\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$
C_{OSS}	Common source output capacitance	–	40	55		
C_{RSS}	Reverse transfer capacitance	–	15	25		
$t_{d(ON)}$	Turn-on delay time	–	–	15	ns	$V_{DD} = 25\text{V}$, $I_D = 300\text{mA}$, $R_{GEN} = 25\Omega$,
t_r	Rise time	–	–	20		
$t_{d(OFF)}$	Turn-off delay time	–	–	15		
t_f	Fall time	–	–	15		
Diode Parameters						
V_{SD}	Diode forward voltage drop	–	–	1.8	V	$V_{GS} = -5.0\text{V}$, $I_{SD} = 300\text{mA}$ (Note 1)
t_{rr}	Reverse recovery time	–	800	–	ns	$V_{GS} = -5.0\text{V}$, $I_{SD} = 300\text{mA}$ (Note 2)

Note 1: All DC parameters are 100% tested at 25°C unless otherwise stated. Pulse test: 300 μs pulse, 2% duty cycle.

2: Specification is obtained by characterization and is not 100% tested.

DN2450

TABLE 1-2: TYPICAL THERMAL RESISTANCE

Package	θ_{ja}
TO-252 (D-PAK)	81°C/W
TO-243AA (SOT-89)	133°C/W

TABLE 1-3: THERMAL CHARACTERISTICS

Package	I_D^1 continuous (mA)	I_D pulsed (mA)	Power Dissipation @ $T_A = 25^\circ\text{C}$ (W)	I_{DR}^1 (mA)	I_{DRM} (mA)
TO-252 (D-PAK)	350	1000	2.5 ²	350	1000
TO-243AA (SOT-89)	230	900	1.6 ²	230	900

1. I_D continuous is limited by max rated T_j
2. Mounted on FR4 board, 25mm x 25mm x 1.57 mm

2.0 PIN DESCRIPTION

The locations of the pins are listed in [Package Type](#).

TABLE 2-1: PIN DESCRIPTION

Pin # TO-252	Pin # TO-243AA	Function
1	1	GATE
3	3	SOURCE
2,4	2,4	DRAIN

3.0 APPLICATION INFORMATION

Figure shows the switching waveform and test circuit for DN2450.

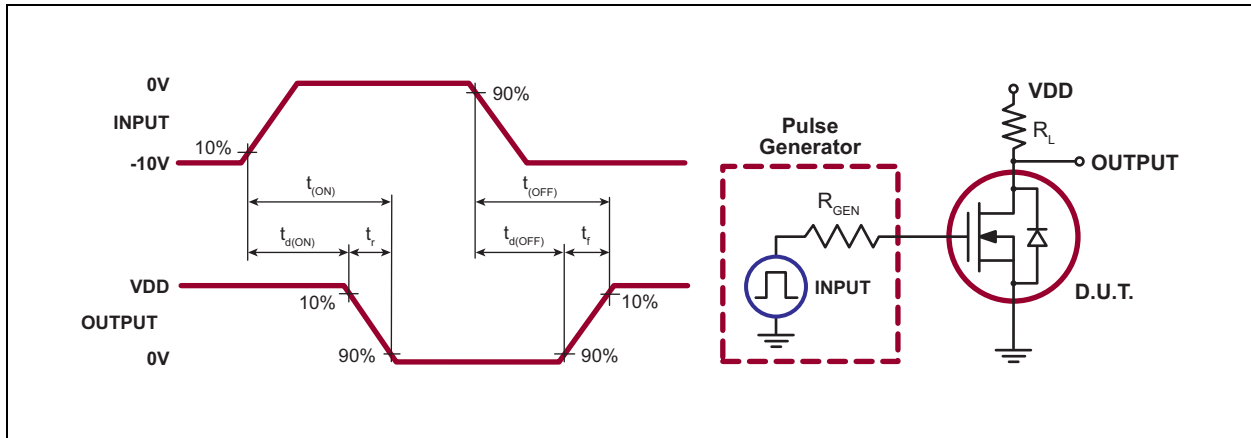


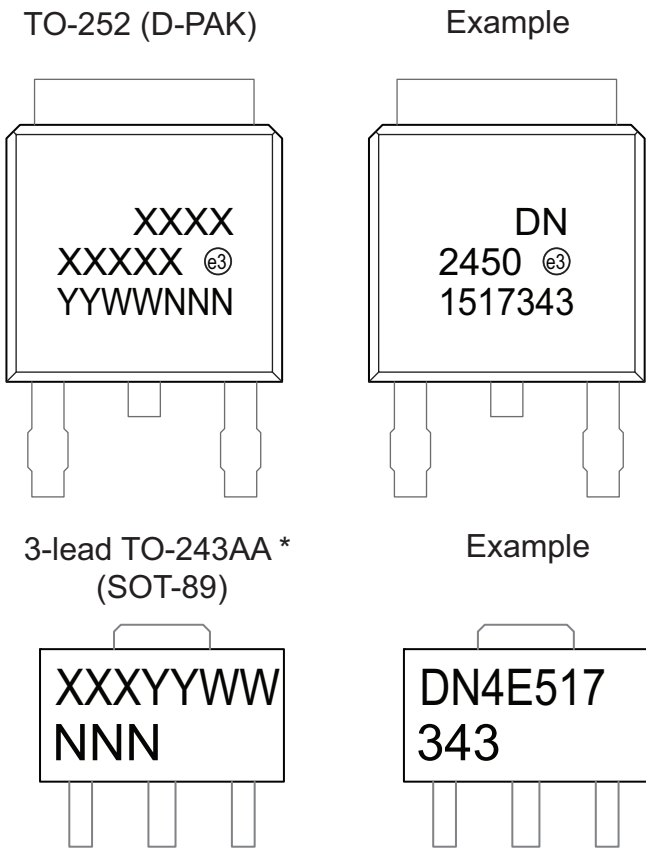
FIGURE 3-1: Switching Waveforms and Test Circuit

Product Summary

BV_{DSX}/BV_{DGX} (V)	$R_{DS(ON)}$ (max) (Ω)	I_{DSS} (min) (mA)
500	10	700

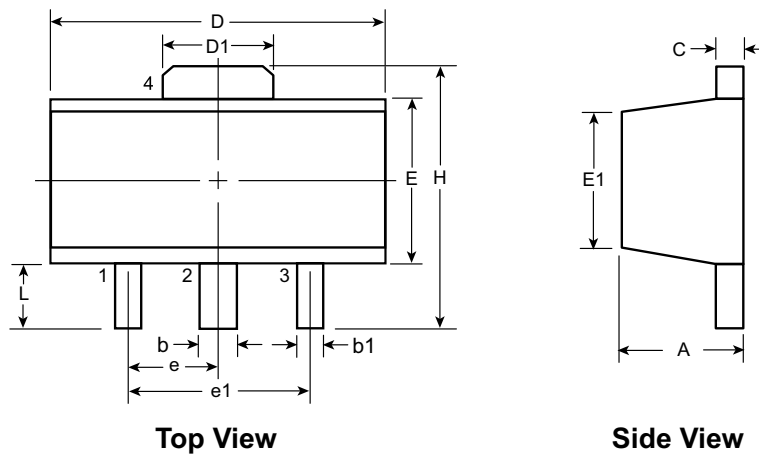
4.0 PACKAGING INFORMATION

4.1 Package Marking Information



Legend:	XX...X	Product Code or Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	e3	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.		

3-Lead TO-243AA (SOT-89) Package Outline (N8)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

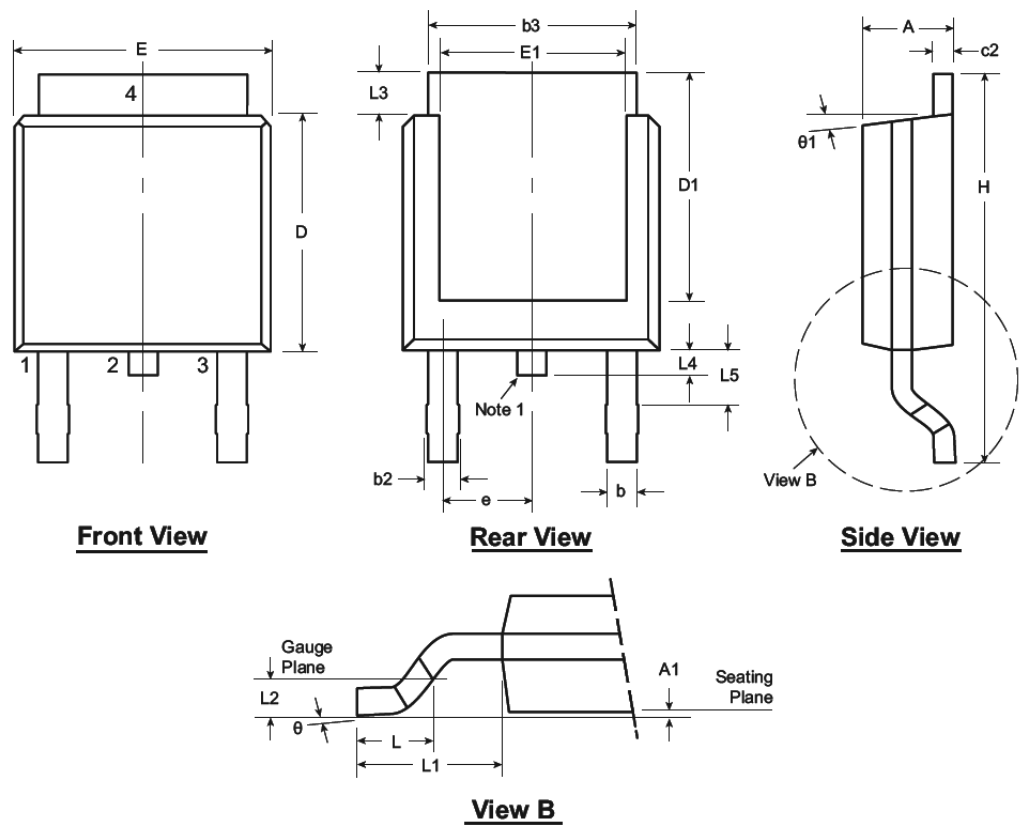
Symbol		A	b	b1	C	D	D1	E	E1	e	e1	H	L
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00 [†]	1.50 BSC	3.00 BSC	3.94	0.73 [†]
	NOM	-	-	-	-	-	-	-	-			-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

[†] This dimension differs from the JEDEC drawing

Drawings not to scale.

3-Lead TO-252 (D-PAK) Package Outline (K4)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:
1. Although 4 terminal locations are shown, only 3 are functional. Lead number 2 was removed.

Symbol		A	A1	b	b2	b3	c2	D	D1	E	E1	e	H	L	L1	L2	L3	L4	L5	θ	θ1
Dimension (inches)	MIN	.086	.000*	.025	.030	.195	.018	.235	.205	.250	.170	.090 BSC	.370	.055	.108 REF	.020 BSC	.035	.025*	.035*	0°	0°
	NOM	-	-	-	-	-	.240	-	-	-	-		.060	-			-	-	-	-	
	MAX	.094	.005	.035	.045	.215	.035	.245	.217*	.265	.200*		.410	.070			.050	.040	.060	10°	15°

JEDEC Registration TO-252, Variation AA, Issue E, June 2004.
* This dimension is not specified in the JEDEC drawing.
† This dimension differs from the JEDEC drawing.
Drawings not to scale.

APPENDIX A: REVISION HISTORY

Revision A (July 2015)

- Update file to new format

DN2450

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>XX</u>	-	<u>X</u>	-	<u>X</u>
Device	Package Options		Environmental		Media Type
Device:	DN2450	=	N-Channel, Depletion-Mode, vertical DMOS FET		
Package:	K4	=	TO-252 (D-PAK)		
	N8	=	TO-243AA (SOT-89)		
Environmental	G	=	Lead (Pb)-free/ROHS-compliant package		
Media Type:	(blank)	=	2000/Reel		
Examples:					
a)	DN2450K4-G				TO-252 package, 2000/reel
b)	DN2450N8-G				TO-243AA package, 2000/reel

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